Alloys that we've selected

• SN100C

- Nihon Superior Patented Alloy
- Wave Solder Only
- Tin 99% Copper 0.5% Nickel 0.05%
- Melting Point 227° C
- Lower Cost Pb Free Alternative No Silver
- Can be run at 500° F
 - Other wave solder alloys are 525° F 530° F
- Trace Elements of Nickel effect solidification of solder
 - Visibly Tighter Grain Structure
 - Tighter Grain Structure = Increased Joint Strength

		SnPb	SN100C	Δ
Wave	Top Side Preheat	180~210C	200~240C	20~30C
	Pot Temperature	250~260C	260~280C	0~20C



Why SN100C?

- True Eutectic Alloy
 - No Plastic State
- Behaves more like SnPb
- Current Standard in Japan
- Detailed Reliability Data being released March 16th.
- JCAA/JG-PP Study to release data
 - Preliminary Findings Excellent for SN100C
 - APSCO Participating in Study



Properties of SN100C

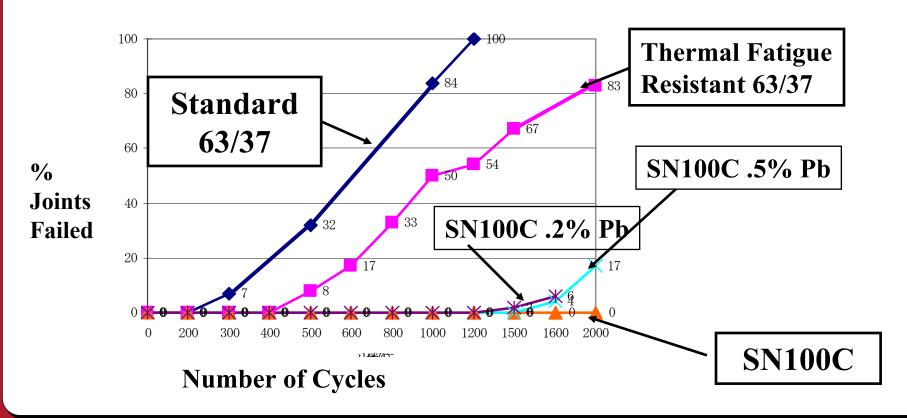
	ALLOY		METHOD			
PROPERTY	SN100C	63Sn/37Pb				
Tensile Strength kgf/mm²	3.3	4.5	10mm/min 25° C			
Elongation %	48	25	10mm/min 25° C			
Creep Strength	>300hr	20hr	145°C 1kg load			
Time to Failure	>300hr	/3hr	150° C 1kg load			
	>300hr	7min	180° C 1kg load			
Thermal Cycle Cycles to Failure	>1000	500-600	- 40° C/+80° C			





Properties of SN100C

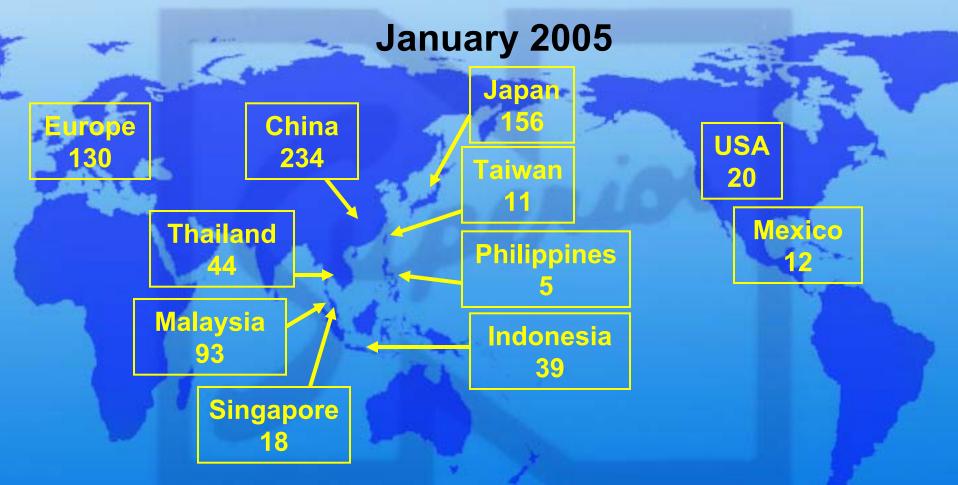
Thermal Cycle Testing







WAVE SOLDERING MACHINES RUNNING WITH Ni-Modified Sn-Cu Eutectic



Total: 756+103 Scheduled

An increase of 91 over the December/ January period



Experience with SN100C

COMPANY	PRODUCTS MADE WITH SN100C		
Matsushita	Video, Vacuum Cleaner, Microwave Oven, Rice Cooker, Air conditioner, Refrigerator, Dehumidifier, Lighting		
Pioneer	PDP/CATV Tuner, DVD-RW, DVD Audio		
Seiko Epson	Printer, Components		
Mitsumi	Hand Phone Battery Charger		
Hitachi	Notebook Computer, Dehumidifier, Refrigerator		
Sony	Car CD Player, PA System		
Fuji Xerox	Photocopier /		
Fuji Film	Camera		
Daikin	Air conditioner		
Fiji Electric Wire	Wire Coating		





Experience with SN100C

Estimate more than
200 million
printed circuit board assemblies
produced with SN100C
and in service
since 1999.





Why SN100 rather than Sn-0.7%Cu

Wave Soldering at 250°C, 3-4 second contact time



Sn-0.7%Cu



No Bridging

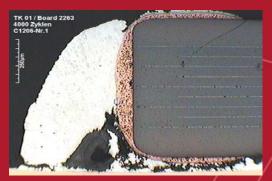


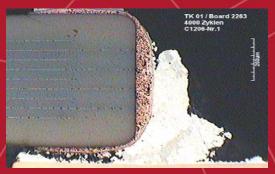


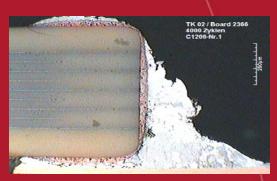
Reliability Comparison

SN100CL HASL / FR4 / CMC1206: 4000 cycles -40 - +125°C

63/37 Sn/Pb

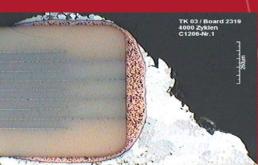






SAC alloy











JCAA/JG-PP Test Results on SN100C



Preliminary & Confidential

Vibration Test Data (Manufactured Vehicles)

			Relative Solder Ranking			
Component	Reference Designator	Solder/Finish	Sn37Pb	Sn3.9Ag0.6Cu	Sn3.4Ag1.0Cu3.3Bi	Sn0.7Cu0.05Ni
PDIP-20	U8	Pb-Free/NiPdAu or SnPb/NiPdAu	3	2		1
PDIP-20	U23	Pb-Free/NiPdAu or SnPb/NiPdAu	Not enough failures to rank			
PDIP-20	U35	Pb-Free/NiPdAu or SnPb/NiPdAu	3	2		1
PDIP-20	U49	Pb-Free/NiPdAu or SnPb/NiPdAu	3	2		1
PDIP-20	U59	Pb-Free/NiPdAu or SnPb/NiPdAu	Not enough failures to rank			
PDIP-20	U11	Pb-Free/Sn or SnPb/Sn	2	3		1
PDIP-20	U30	Pb-Free/Sn or SnPb/Sn	1	2		1
PDIP-20	U38	Pb-Free/Sn or SnPb/Sn	2	1		1
PDIP-20	U51	Pb-Free/Sn or SnPb/Sn	2	3		1
PDIP-20	U63	Pb-Free/Sn or SnPb/Sn	2	3		1



Comparing SN100C with Tin/Lead



Sn-37Pb



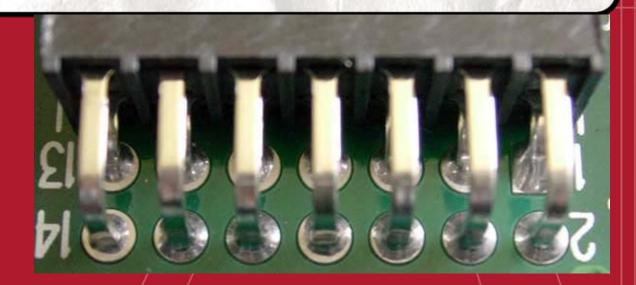
SN100C

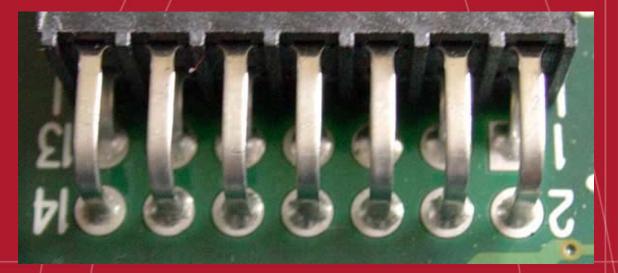




Comparing SN100C with Tin/Lead

Sn-37Pb







Comparing SN100C with Tin/Lead

Sn-37Pb







